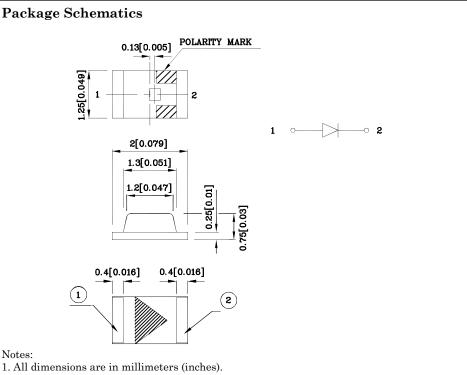


2.0x1.25mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- \bullet RoHS compliant





2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.

3. Specifications are subject to change without notice.

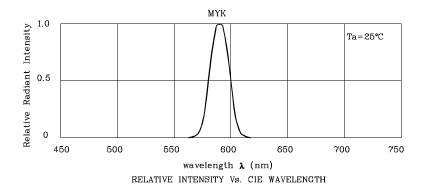
Absolute Maximum Ratings (T _A =25°C)		MYK (AlGaInP)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	175	mA	
Power Dissipation	PD	75	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		

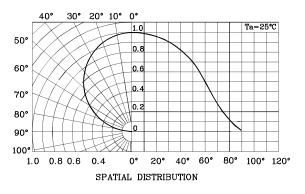
Operating Characteristics (T _A =25°C)			MYK (AlGaInP)	Unit	
Forward Voltag (I _F =20mA)	e (Typ.)	$V_{\rm F}$	2	V	
Forward Voltag (I _F =20mA)	e (Max.)	$V_{\rm F}$	2.5	V	
Reverse Current (Max.) (V _R =5V)		I_R	10	uA	
Wavelength of Peak Emission CIE127-2007*(Typ.) (I _F =20mA)		λP	590*	nm	
Wavelength of Dominant Emission CIE127-2007*(Typ.) (I _F =20mA)		λD	590*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)		$ riangle \lambda$	20	nm	
Capacitance (Typ.) V _F =0V, f=1MHz)		С	20	pF	
Lens-color	or $\begin{array}{c} \text{Luminous Intensity}\\ \text{CIE127-2007*}\\ \text{(I}_{\text{F}}=20\text{mA})\\ \text{mcd} \end{array}$		Wavelength CIE127-2007* nm \\P	Viewing Angle 2θ 1/2	

 Part Number	Emitting Color	Emitting Material	Lens-color	CIE127-2007* (I _F =20mA) mcd		CIE127-2007* nm λP	Viewing Angle 2θ 1/2
				min.	typ.		
ZMYK54W-1	Yellow	AlGaInP	Water Clear	80*	148*	590*	120°

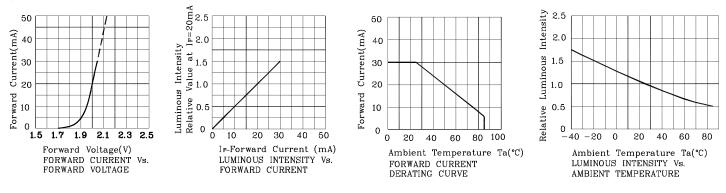
 ${\rm *Luminous\ intensity\ value\ and\ wavelength\ are\ in\ accordance\ with\ CIE127-2007\ standards.}$







✤ MYK



LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

300 (°C) 10 s max iner? 250 4°C/s C/s max 200 150~180 4°C/s max 150 Temperature 30~50s 60~120s 100 50 0 150 0 50 100 200 250 300 (sec) Time Notes:

1. Maximum soldering temperature should not exceed 260°C

2. Recommended reflow temperature: 145°C-260°C 3. Do not put stress to the epoxy resin during

high temperatures conditions

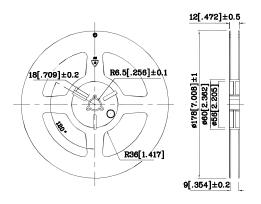


✤ The device has a single mounting surface. The device must be mounted according to the specifications.

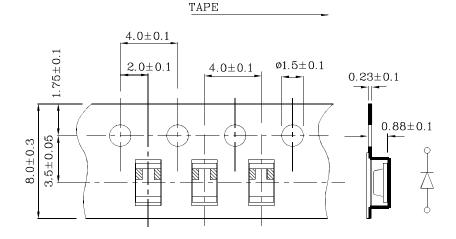
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

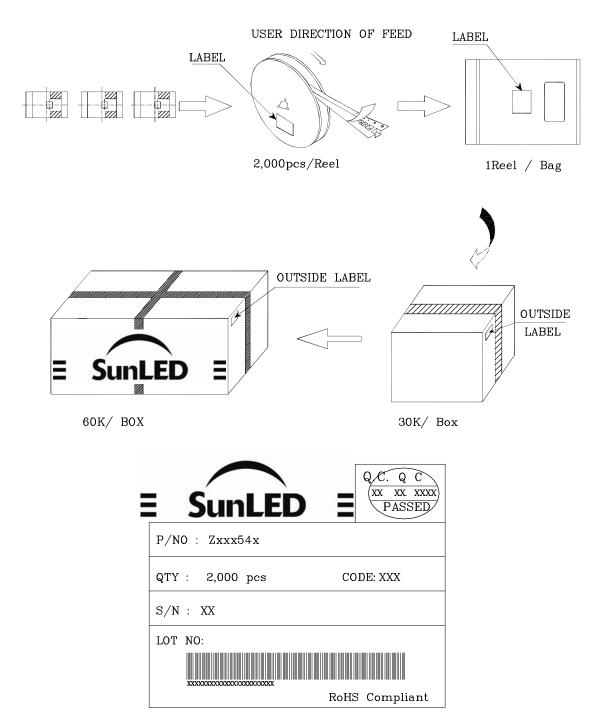
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at http://www.SunLED.com/TechnicalNotes